

描述 / Descriptions

SOP-8 塑封封装 双通道放大器。Dual Operational Amplifiers in a SOP-8 Plastic Package.

特征 / Features

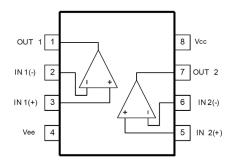
内部单位增益频率补偿,有较大的直流电压增益:100dB,工作电压范围宽(Vcc = 3V ~ 36V),输入共模电压范围接近地电平,输出电压范围大:从 0~Vcc-1.5V,适用于电池工作时的电力消耗。 Internally frequency compensated for unity gain, Large DC voltage gain:100dB, Wide operating supply range (Vcc=3V~36V), Input common mode voltage includes ground, Large output voltage swing: From 0 to Vcc-1.5V, Power drain suitable for battery operation.

用途 / Applications

适用于传感器放大器,直流增益模块和所有传统的运算放大器电路。

Application areas include transducer amplifier, DC gain blocks and all the conventional OP amp circuits.

内部等效电路 / Equivalent Circuit



引脚排列 / Pinning



PIN 见内部等效电路 / PIN See Equivalent Circuit.

印章代码 / Marking

见印章说明 / See Marking Instructions

LM358 Rev.J Oct.-2018



极限参数 / Absolute Maximum Ratings(Ta=25℃)

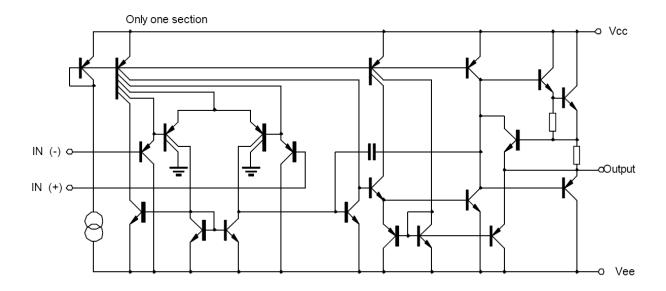
参数	符号	数值	单位
Parameter	Symbol	Rating	Unit
Supply Voltage	V_{CC}	±18	V
Differential input voltage	$V_{I(DIFF)}$	36	V
Input Voltage	VI	-0.3~36	V
Power Dissipation	P_d	570	mW
Operating Temperature	T _{opr}	0 ~ 70	°C
Storage Temperature	T _{stg}	-65 ~ 150	°C

电性能参数 / Electrical Characteristics(Ta=25°C)

参数	符号	测试条件	最小值	典型值	最大值	单位
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Input offset voltage	V _{IO}	V_{CM} =0 to Vcc-1.5 $V_{o(p)}$ =1.4V R_s =0		2.0	3.0	mV
Input offset current	I _{IO}			2.0	30	nA
Input Bias current	I _b			45	100	nA
Input Commonmode voltage range	$V_{I(R)}$	V _{cc} =30V	0	V _{CC} -1.5		V
Supply Current	I _{cc}	R _L =∞ V _{cc} =30V		8.0	2.0	mA
		V _{cc} =5V		0.5	1.2	mA
Large signal Voltage Gain	G _V	V_{cc} =15V R _L >2k Ω V _{o(p)} =1V to 11V	25	100		V/mV
Output voltage Swing	V _(OH)	V_{cc} =30V R_L =2k Ω	26			V
		V_{cc} =30V R_L =10k Ω	27	28		V
	$V_{(OL)}$	V_{cc} =5V R_L =10k Ω		5	20	mV
Commonmode rejection Ratio	CMRR		65	75		dB
Power supply rejection Ratio	PSRR		65	100		dB
Chanel Sepparation	CS	f=1kHz to 20kHz		5	20	mV
Short circuit to GND	I _{sc}			40	60	mA
Output current	I _{source}	$V_{I(+)}=1V$ $V_{I(-)}=0$ $V_{cc}=15V$ $V_{o(p)}=2V$	20	40		mA
	I _{sink}	$V_{I(+)}=0V$ $V_{I(-)}=1V$ $V_{cc}=15V$ $V_{o(p)}=2V$	10	13		mA
		$V_{I(+)}=1V$ $V_{I(-)}=0$ $V_{cc}=15V$ $V_{o(p)}=200mV$	12	45		μΑ
Differential input voltage	$V_{I(diff)}$				V _{cc}	V

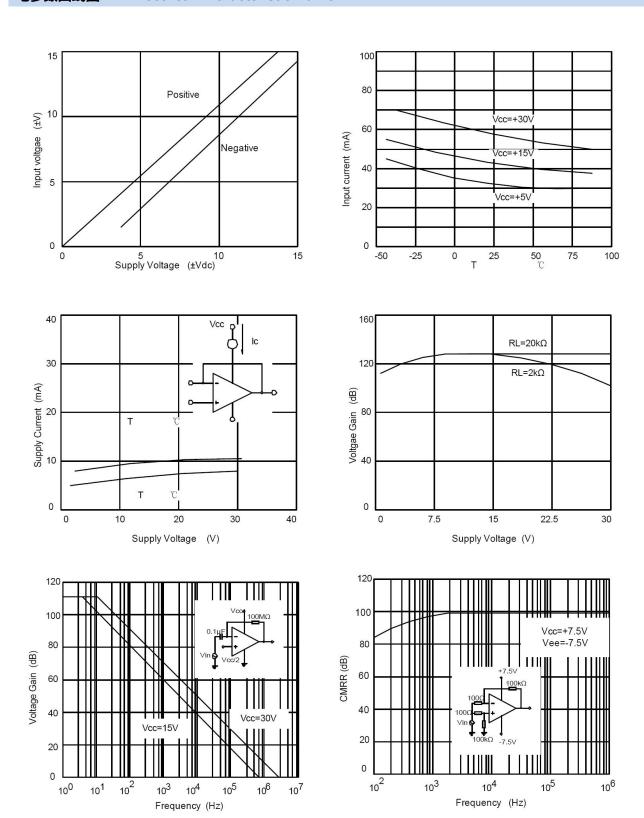


原理框图 / Functional Block Diagram



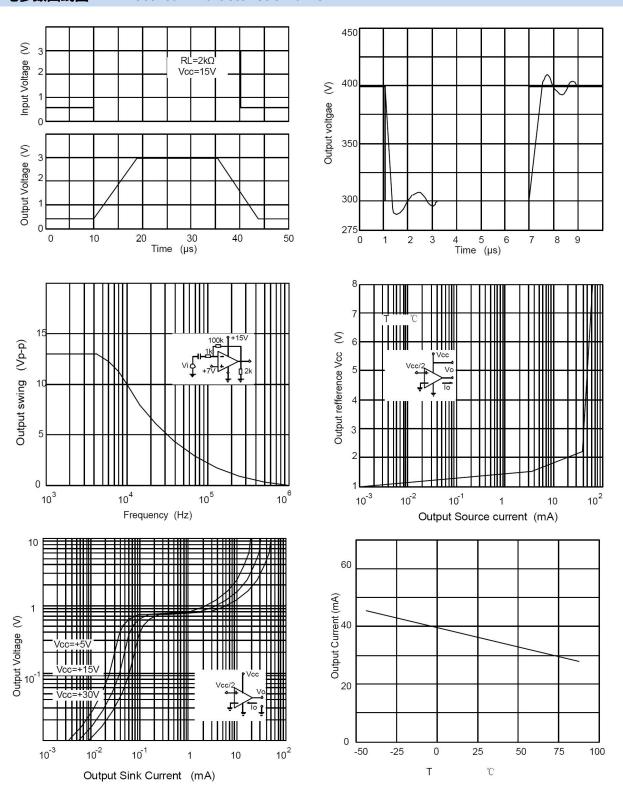


电参数曲线图 / Electrical Characteristic Curve





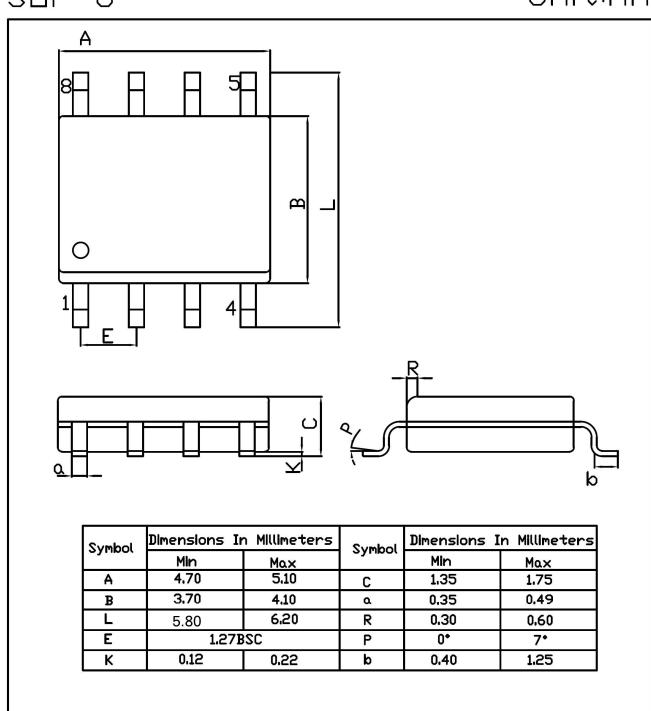
电参数曲线图 / Electrical Characteristic Curve





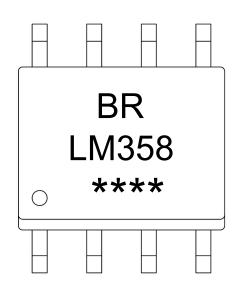
外形尺寸图 / Package Dimensions







印章说明 / Marking Instructions



说明:

BR: 为公司代码

LM358: 为型号代码

****: 为生产批号代码,随生产批号变化

Note:

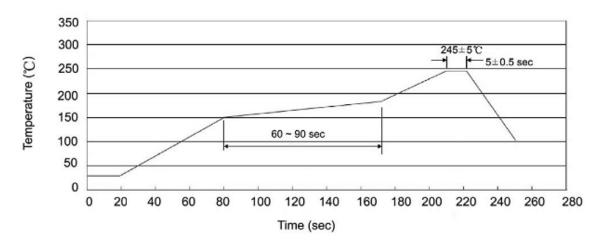
BR: Company Code.

LM358: Product Type.

****: Lot No. Code, code change with Lot No.



回流焊温度曲线图(无铅) / Temperature Profile for IR Reflow Soldering(Pb-Free)



说明:

1、预热温度 150~180℃, 时间 60~90sec;

2、峰值温度 245±5℃, 时间持续为 5±0.5sec;

3、焊接制程冷却速度为 2~10℃/sec.

Note:

1.Preheating:150~180°C, Time:60~90sec.

2.Peak Temp.:245±5°C, Duration:5±0.5sec.

3. Cooling Speed: 2~10°C/sec.

耐焊接热试验条件 / Resistance to Soldering Heat Test Conditions

温度: 260±5℃ 时间: 10±1 sec. Temp.:260±5℃ Time:10±1 sec

包装规格 / Packaging SPEC.

卷盘包装 / REEL

Package Type . 封装形式	Units 包装数量				Dimer	nsion 包装尺寸 (unit: mm³)		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box 盒	Outer Box 箱
SOP/ESOP-8	4,000	2	8,000	6	48,000	13" ×12	360×360×50	380×335×366

使用说明 / Notices